

Epitaxial growth of $\text{Pb}(\text{Zr}_{0.2}\text{Ti}_{0.8})\text{O}_3$ on Si and its nanoscale piezoelectric properties

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We have demonstrated a route to epitaxial $\text{Pb}(\text{Zr}_{0.2}\text{Ti}_{0.8})\text{O}_3$ on (001) Si that exhibits a uniform piezoelectric response down to nanoscale levels through the utilization of an insulating, single-crystalline SrTiO_3 transition layer. These structures, which were grown by a combination of molecular-beam epitaxy and off-axis magnetron sputtering, have a surface roughness of $<5 \text{ \AA}$, with piezoelectric microscopy measurements revealing a piezoelectric coefficient of $\sim 50 \text{ pm/V}$ that is switchable down to sub-100-nm dimensions. © 2001 American Institute of Physics.

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Complex oxides exhibit a tremendous diversity of behavior, including magnetism, superconductivity, ferroelectricity, and piezoelectricity. The ability to integrate this versatile functionality in thin-film form with mainstream technology like Si processing opens broad opportunities for scientific and technological applications. For example, there has been much interest in interfacing polycrystalline and amorphous oxides and related materials with single-crystal Si for microelectronics applications, utilizing them as high-dielectric-constant insulators to replace SiO_2 as a gate oxide.¹

Here, we demonstrate another possibility, which is to couple atomically smooth, epitaxial ferroelectric oxides with single-crystal Si. In addition to their potential utility for microelectronics, these structures are also intrinsically piezoelectric, often with very large piezoelectric coefficients. This property makes them very attractive for microelectromechanical applications, such as sensing and actuation.² They have also been investigated for high-density, nonvolatile, piezoelectric memory applications using scanning probes.³ The work presented here focuses on the nanoscale piezoelectric properties of such materials.

While there has been significant effort to grow these materials on Si, to date, much of that work has focused on synthesis techniques like sol-gel processing and sputtering onto amorphous or polycrystalline surfaces, which produce amorphous or polycrystalline thin films.^{2,4} These results have demonstrated impressive bulk electromechanical coupling, but as progress is made towards smaller, nanoscale applications, for example, nanoelectromechanical systems (NEMS), where uniform control of the piezoelectric response over nanometer length scales is required, microstructural inhomogeneities in these polycrystalline films will eventually compromise performance.⁵

Ghonge *et al.* and Maruyama *et al.* have achieved crystalline growth of $\text{Pb}_{0.9}\text{La}_{0.1}(\text{Zr}_{0.2}\text{Ti}_{0.8})_{0.975}\text{O}_3$ and $\text{Pb}(\text{Zr}_{0.25}\text{Ti}_{0.75})\text{O}_3$, respectively, on Si using a combination of

three buffer layers.^{6,7} However, in each case, one of the buffer layers is conducting and screens the Si from the ferroelectric polarization. Here, we demonstrate the epitaxial growth of $\text{Pb}(\text{Zr}_{0.2}\text{Ti}_{0.8})\text{O}_3$ (PZT) on Si using an insulating SrTiO_3 transition layer. With this composite dielectric structure on Si, one can envision microelectronics applications where the polarization field of the ferroelectric modulates the electrical transport properties of the Si substrate.

These ferroelectric/Si heterostructures are nearly atomically smooth [$<5 \text{ \AA}$ root-mean-square (rms) roughness] and exhibit a highly uniform piezoelectric response, with isolated, sub-100-nm ferroelectric domains having been polarized and imaged. Figure 1 illustrates hysteresis data obtained for the d_{33} piezoelectric coefficient of these materials measured using piezoelectric microscopy; the piezoelectric coefficient is on the order of 50 pm/V , in agreement with measurements taken on epitaxial $\text{Pb}(\text{Zr}_{0.2}\text{Ti}_{0.8})\text{O}_3$ grown on metallic, Nb-doped single-crystal SrTiO_3 substrates.⁸ The details of the hysteretic shape of the data and charge modulation in the semiconductor will be discussed elsewhere; our primary consideration here is the piezoelectric response of these structures.⁹

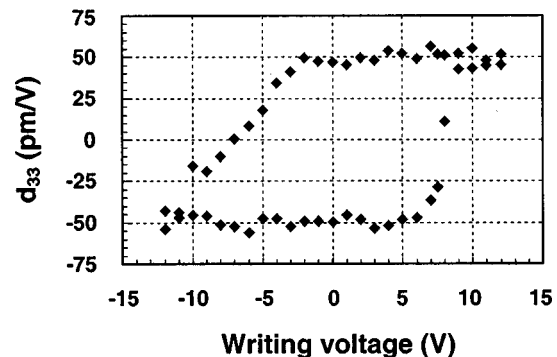


FIG. 1. Small-signal piezoelectric response of a PZT/ SrTiO_3 /Si heterostructure as a function of the writing voltage used to establish the ferroelectric polarization state. The zero of the piezoelectric response is defined as the mean of the positive and negative deflections measured at saturation.

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To carry out this work, we have employed a methodology for interfacing crystalline oxides with single-crystal Si (COS) developed by McKee and co-workers.^{10,11} This approach is centered around the layer-by-layer stabilization of the semiconductor–oxide interface, wherein the constituents of a crystalline oxide are grown in a sequenced transition from the covalently bonded semiconductor to the ionically bonded oxide. This technique can completely avoid amorphous SiO₂ at the interface. It works well with the group IIA perovskites in the CaTiO₃ class because the alkaline-earth-oxide layer against silicon is itself stable, but it cannot be applied to Pb-based perovskites since SiO₂ is more stable than PbO, preventing direct growth of single-crystalline PZT on Si. We have, therefore, used a variation of the COS approach by growing the stable SrTiO₃ perovskite on silicon and then transitioning to PZT.

The PZT/SrTiO₃/Si structures we have investigated were grown by a combination of molecular-beam epitaxy (MBE) and off-axis magnetron sputtering. SrTiO₃-terminated Si (*p* type) was first fabricated using the MBE methods described in Ref. 10. The samples were then transferred in air to an off-axis magnetron sputtering system, where epitaxial tetragonal PZT was deposited, as described in Refs. 12–16. Prior to deposition, the SrTiO₃-terminated Si was held in the sputtering background gas at 500 °C for a few minutes to remove contaminants from the surface. No other surface treatment was necessary, indicating the robustness of the SrTiO₃/Si surface. This procedure has also been used for the growth of LaAlO₃ on SrTiO₃/Si.¹¹

After growth, the structural properties of the PZT/SrTiO₃/Si heterostructures were characterized using x-ray diffraction. Figure 2(a) shows a θ – 2θ scan, which reveals *c*-axis-oriented PZT on SrTiO₃/Si, with a PZT *c*-axis lattice parameter of 4.12 Å. While a small fraction of the film is *a*-axis oriented, no other impurity phases are detected. Figures 2(b) and 2(c) show off-axis ϕ scans of the PZT(111) and SrTiO₃(111) reflections. The fourfold symmetry of the scans and the alignment of the peaks in the two scans with respect to each other demonstrate epitaxial growth of PZT on SrTiO₃/Si. For this orientation of PZT, the ferroelectric polarization should lie parallel to the surface normal. Capacitance–voltage (*C*–*V*) measurements taken on metal–oxide–semiconductor capacitor structures fabricated from these samples confirm this direction of the polarization; a clockwise ferroelectric hysteresis in the *C*–*V* data is observed, demonstrating the direct electrical coupling of the ferroelectric polarization to the charge state in the underlying *p*-type Si.⁹

We have also used atomic-force microscopy (AFM) to examine the surface structure of these materials. Topographic imaging of a 2 μm × 2 μm region reveals a surface with 4-Å-rms roughness, the same as that of the SrTiO₃ surface before the deposition of PZT. This scanning probe approach can also be used to examine the nanoscale piezoelectric properties of the PZT/SrTiO₃/Si structures. In this technique, which is described in detail elsewhere, a conducting AFM tip is scanned in contact with the surface of the sample.^{15,16} To define the local ferroelectric polarization state, and hence, the sign of the piezoelectric response, a voltage exceeding the coercive voltage is applied between

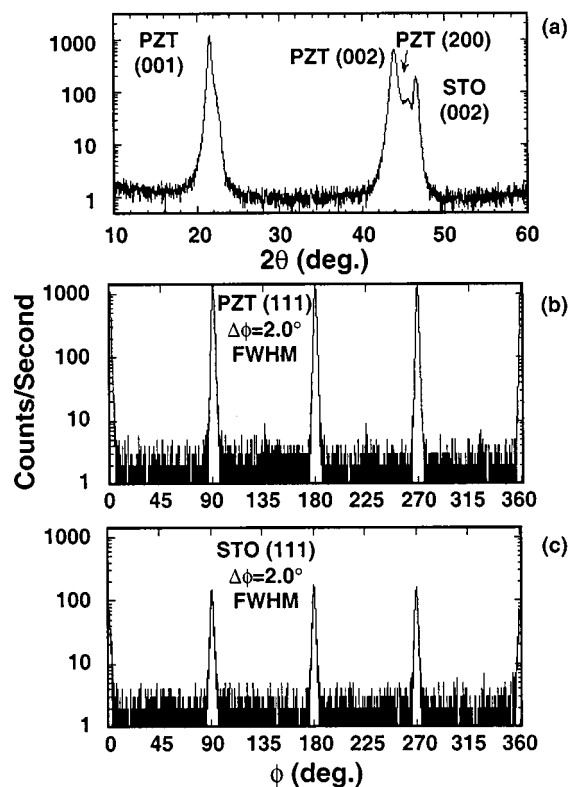


FIG. 2. X-ray characterization of a PZT/SrTiO₃/Si heterostructure. (a) θ – 2θ diffraction scan of the thin-film heterostructure. (b) Off-axis ϕ scan showing the fourfold symmetry of the SrTiO₃ film. (c) Off-axis ϕ scan showing the fourfold symmetry of the PZT film. The alignment of the PZT and SrTiO₃ peaks demonstrates the epitaxial relationship between the two oxides.

the tip and the Si substrate during scanning. In order to image the resulting domain structure, the tip is scanned in contact with the sample while applying a small voltage (less than the coercive voltage) across the sample, inducing a local piezoelectric response. To increase the sensitivity of the measurement, standard ac lock-in detection is used for the deflection signal from the AFM.

With this technique, we have obtained the piezoelectric hysteresis loop shown in Fig. 1. To acquire these data, which were taken on a 500 Å PZT/250 Å SrTiO₃/Si heterostructure, a voltage was applied to a particular region of the sample to establish the local polarization state of the material, and the corresponding piezoelectric response was measured. By repeating this measurement for a series of different writing voltages, the ferroelectric hysteresis of the material is revealed.

The data in Fig. 1 demonstrate two distinct piezoelectric responses that correspond to the two polarization states of the material. The switching voltage we measure for the heterostructure is ~ 7 V, which is much larger than the expected coercive voltage of 0.5 V for the PZT layer itself (assuming a coercive field of ~ 100 kV/cm, the bulk value for Pb(Zr_{0.2}Ti_{0.8})O₃). The discrepancy between the two values is due to the fact that most of the applied voltage drop occurs across the SrTiO₃ layer in the heterostructure, as well as in the small (few Å) vacuum gap that exists between the conducting AFM tip and the sample.^{14–16} One can estimate the value of the piezoelectric coefficient d_{33} by considering the distribution of the fields in the structure. Assuming the dif-

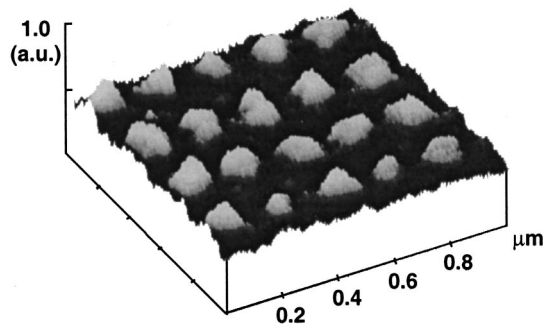


FIG. 3. Piezoelectric image of 20 small (100 nm) domains. The contrast in the image corresponds to the 0.5 \AA/V piezoelectric response of the PZT/SrTiO₃/Si heterostructure.

ference in the observed coercive field and the expected coercive field (100 kV/cm) is due to the nonpiezoelectric layers, the value we find for the piezoelectric coefficient is $\sim 50 \text{ pm/V}$, in agreement with quantitative measurements using scanning tunneling microscopy (50 pm/V) on epitaxial PZT thin films grown on Nb-doped single-crystal SrTiO₃ substrates.⁸

We have also used this scanning probe microscopy approach to define and pattern the local piezoelectric properties over arbitrary, small regions of the film. Figure 3 shows a piezoelectric image of 20 polarized domains, which were written with 10 V inside an oppositely polarized background. The diameters of the 20 domains, as determined by the full width at half maximum of the piezoelectric signal, range from 80 to 120 nm. The corresponding topographic image of this area is featureless, confirming that the domain contrast is indeed piezoelectric in origin. These domains are stable for at least seven days, the longest time we carried out measurements on these samples. We attribute the ability to write these small nanofeatures in a controlled fashion to the epitaxial, smooth surface of the films grown on the SrTiO₃-terminated Si.

The robust piezoelectric response of these PZT films on Si, combined with the high surface quality and highly controllable piezoelectric properties of these materials at the nanoscale level, offer several possibilities for applications ranging from NEMS, where uniform control of the piezoelectric response is required at the nanometer level, to high-density, nonvolatile, piezoelectric memories using scanning probes. In addition, the direct electrical coupling of a ferro-

electric to Si through an insulator enables one to envision extending this single-crystalline approach to microelectronics applications that utilize the polarization field of ferroelectrics to modulate the electronic properties of the Si semiconductor.^{9,17}

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